Prototyping Adapters

Use Model GDPA-K1 to:

- Place SMT parts in an easy-to-use DIP format for prototyping
- Get unlimited uses from SMT parts for use in solderless breadboarding applications
- Assemble "daughter" cards for printed circuit board retrofits.
 SMT adapter will fit directly into previous through-hole footprint.
- Learn SMT soldering skills in classroom or lab.
- Decrease costs by utilizing previously hard-to-find through hole components readily available in SMT format

Model GSPA-K1 Surface Mount to DIP Adapter Kit



Features:

- Set of six adapter boards in an array of convenient sizes
- Can be used with Global Specialties Electronic Trainers, Premium and Economy Prototyping Solderless Breadboards
- Ideal for service, prototype and experimental and educational use
- Small footprint. Approximately the same size as DIP socket equivalent component
- ► Individual boards available in high quantities for production retrofits
- Made in USA

Global Specialties Surface Mount Adapter Kit, Model GSPA-K1 is a collection of SOIC and SSOP to DIP Adapter Sockets, which allow the user to solder popular pinconfigured surface mount integrated circuits onto a platform that is easily adaptable to solderless breadboards or existing circuit layouts. Once the surface mount IC is mounted to the DIP adapter, it becomes re-usable in prototyping applications, similar to other through-hole ICs, saving time and money.

The GSPA-K1 is perfect for educational prototyping and experiment applications, as well as production retrofits and daughter board configurations. Package contents include the following.

Specifications

Set of six adapter boards including:

SOIC to DIP – 8 pins: 300 Mil Span – 2ea SOIC to DIP – 14 pins: 300 Mil Span – 1 ea SOIC to DIP – 16 pins: 300 Mil Span – 1 ea SOIC to DIP – 24 pins: 300 Mil Span – 1 ea SSOP to DIP – 8 pins: 300 Mil Span – 1 ea



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